VOLTAGE RANGE

3.3 Volts

200 Watts Peak Power

FEATURES

- 200 Watts Pulse capability
- Excellent clamping capability
- Low incremental surge resistance
- Fast response time
- High temperature soldering guaranteed: 260°C/10 seconds at terminals
- Component inaccordance to RoHS 2011/65/EU

- "GK" represents the brand name
- "XXX" represents the periodic code
- "YY" represents the product type marking

MECHANICAL DATA

- Case: SOD-123FL molded plastic body
- Terminals: Solder Plated
- Polarity: By cathode band denotes uni-directional device, none cathode band denotes bi-directional device.

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating 25°C ambient temperature uniess otherwies specified.
Single phase half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

RATINGS	SYMBOL	VALUE	UNITS
Peak Power Dissipation at T_A=25°C, T_P=1ms(NOTE 1)	P_{PK}	Minimum 200	Watts
Peak Forward Surge Current at 8.3ms Single Half Sine-Wave superimposed on rated load (JEDEC method) (NOTE 3)	I_{FSM}	30	Amps
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	°C

NOTES:
1. Non-repetitive current pulse per Fig. 3 and derated above T_A=25°C per Fig. 2.
2. Mounted on Copper Pad area of 5.0mm^2(.013mm Thick) to each terminal.
3. 8.3ms single half sine-wave, duty cycle = 4 pulses per minute maximum.

DEVICES FOR BIDIRECTIONAL APPLICATIONS

- 1. For bi-directional use C suffix for Types .
- 2. Electrical characteristics apply in both directions.

RATING AND CHARACTERISTIC CURVES

FIG.1-PEAK PULSE POWER DERATING CURVE

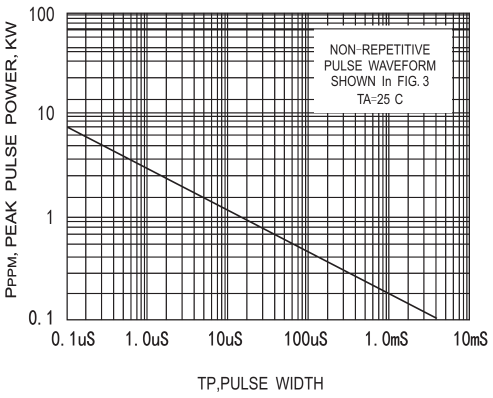


FIG.2-PULSE DERATING CURVE

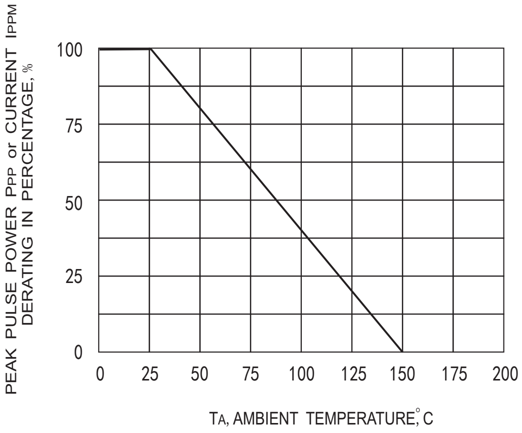


FIG.3-PULSE WAVE FORM

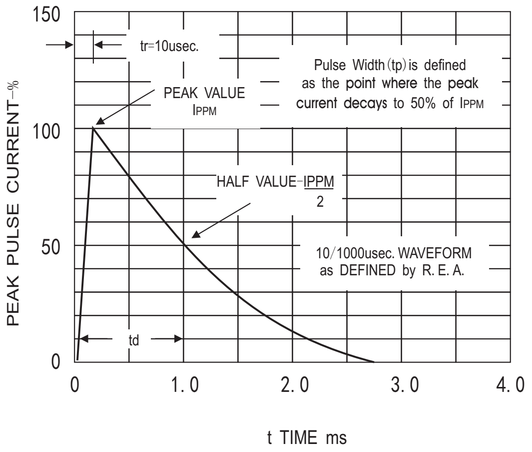
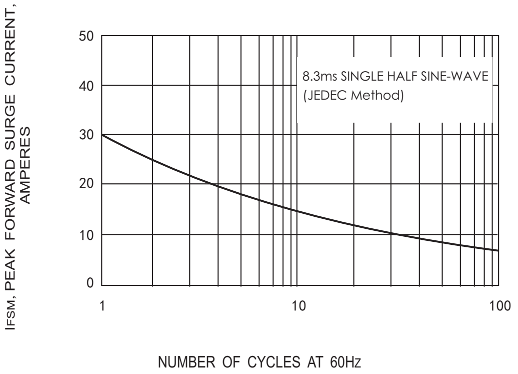


FIG.4-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

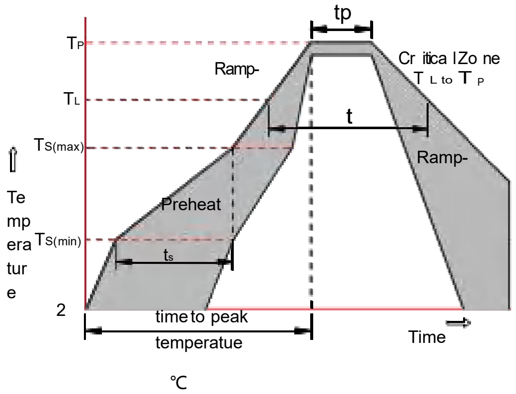


PART NUMBER ADD C FOR BI-DIRECTIONAL	V_{RWM}	Breakdown Voltage V_{BR} @ I_T		Test Current	Reverse Leakage	Max. Clamp Voltage	Peak Pulse Current	Marking
		Min	Max	I_T	I_R @ V_{RWM}	V_C @ I_{PP}	I_{PP}	
See Note 1	V	V	V	mA	μA	V	A	
SMF3.3 A	3.3	4.3	5.30	10	800	7.3	27.4	**3.3 A**

Soldering parameters

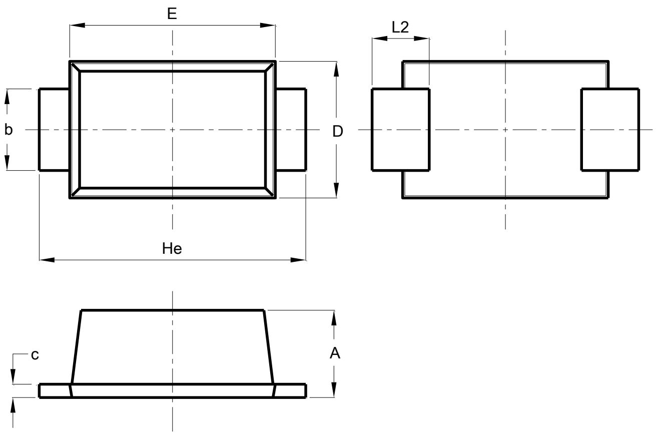
Reflow Condition		Pb-Free assembly (see as bellow)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150℃
	-Temperature Max($T_{s(max)}$)	+200℃
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquid us Temp (T_L) to peak)		3℃/sec. Max
$T_{s(max)}$ to T_L - Ramp-up Rate		3℃/sec. Max
Reflow	-Temperature(T_L)(Liquid us)	+217℃
	-Temperature(t_L)	60-150 secs.
Peak Temp (T_p)		+260(+0/-5)℃
Time within 5℃ of actual Peak Temp (t_p)		30 secs. Max
Ramp-down Rate		6℃/sec. Max
Time 25℃ to Peak Temp (T_P)		8 min. Max
Do not exceed		+260℃

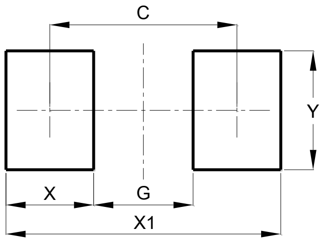
FIG5: Reflow condition



Package Dimensions & Suggested Pad Layout

SOD123FL



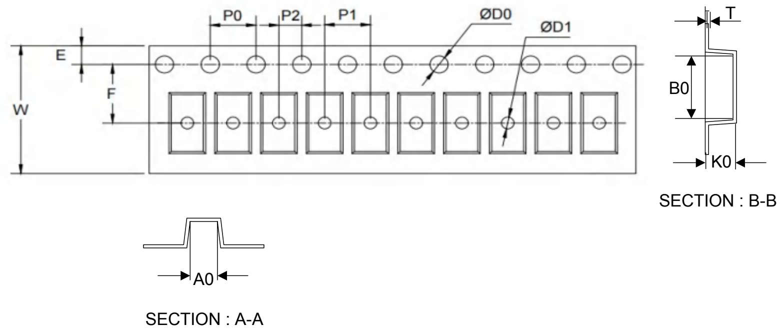


SOD123FL		
Dim	**Min**	**Max**
A	1.00	1.20
b	0.80	1.10
c	0.12	0.20
D	1.75	1.95
E	2.60	2.90
He	3.55	3.80
L2	0.50	0.85
All Dimensions in mm		

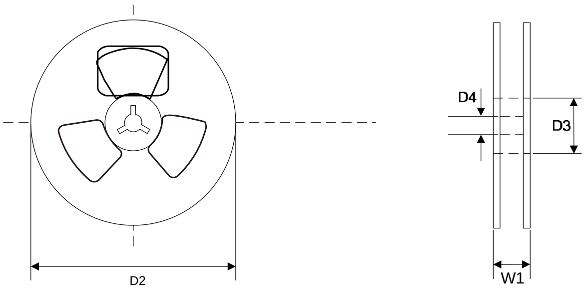
Dimensions	Value (in mm)
C	3.25
G	2.00
X	1.25
X1	4.50
Y	1.50

Tape & rell specification

Tape



7” Reel



Symbol	Dimension (mm)
P0	4.00±0.20
P1	4.00±0.20
P2	2.00±0.20
D0	1.55±0.15
D1	1.00±0.20
E	1.75±0.20
F	3.50±0.25
W	8.00±0.20
A0	1.85±0.20
B0	3.95±0.20
K0	1.30±0.20
T	0.21±0.10
D2	178.0±5.0
D3	55.0Min.
D4	10.0±2.5
W1	11.5±2.5

Quantity: 3000PCS